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NTE2990
MOSFET
P-Channel, Enhancement Mode
High Speed Switch

Features:

- Low Drain–Source On–Resistance
- Low Input Capacitance
- High Avalanche Capability Ratings

Applications:

- Switching Regulators
- UPS
- DC–DC Converters
- General Purpose Power Amplifier

Absolute Maximum Ratings: ($T_A = +25^\circ\text{C}$ unless otherwise specified)

Drain–Source Voltage, V_{DSS}	250V
Gate–Source Voltage, V_{GSS}	$\pm 30\text{V}$
Drain Current, I_D	
Continuous	$\pm 6\text{A}$
Pulsed (Note 1)	$\pm 24\text{A}$
Maximum Power Dissipation, P_D	
$T_C = +25^\circ\text{C}$	35W
$T_A = +25^\circ\text{C}$	2.0W
Single Avalanche Current (Note 2), I_{AS}	6A
Single Avalanche Energy (Note 2), E_{AS}	180mJ
Channel Temperature, T_{ch}	+150°C
Storage Temperature Range, T_{stg}	-55° to +150°C
Thermal Resistance, Junction-to-Ambient, R_{thJA}	62.5°C/W
Thermal Resistance, Junction-to-Case, R_{thJC}	2.77°C/W

Note 1. Pulse Width $\leq 10\mu\text{s}$, Duty Cycle $\leq 1\%$.

Note 2. Starting $T_{ch} = +25^\circ\text{C}$, $R_G = 25\Omega$, $V_{GS} = -20\text{V} \rightarrow 0$.

Electrical Characteristics: ($T_A = +25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain–Source On–State Resistance	$R_{DS(on)}$	$I_D = 3\text{A}, V_{GS} = 10\text{V}$	—	0.55	0.80	Ω
Gate Threshold Voltage	$V_{GS(th)}$	$I_D = 1\text{mA}, V_{DS} = 10\text{V}$	4.0	4.8	5.5	V
Forward Transfer Admittance	g_{fs}	$I_D = 3\text{A}, V_{DS} = 10\text{V}$	2.0	3.5	—	S
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 250\text{V}, V_{GS} = 0\text{V}$	—	—	100	μA
Gate–Source Leakage Current	I_{GSS}	$V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$	—	—	± 100	nA
Input Capacitance	C_{iss}	$V_{DS} = 10\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$	—	1040	—	pF
Output Capacitance	C_{oss}		—	360	—	pF
Reverse Transfer Capacitance	C_{rss}		—	70	—	pF
Turn–On Time	$t_{d(on)}$	$V_{DD} = 125\text{V}, I_D = 3\text{A}, V_{GS(on)} = 10\text{V}, R_G = 10\Omega, R_L = 42\Omega$	—	25	—	ns
Rise Time	t_r		—	16	—	ns
Turn–Off Time	$t_{d(off)}$		—	47	—	ns
Fall Time	t_f		—	14	—	ns
Total Gate Charge	Q_g	$V_{DD} = 200\text{V}, V_{GS} = 10\text{V}, I_D = 6\text{A}$	—	23.1	—	nC
Gate–Source Charge	Q_{gs}		—	7.1	—	nC
Gate–Drain (“Miller”) Charge	Q_{gd}		—	12.9	—	nC

Source–Drain Diode Ratings and Characteristics: ($T_A = +25^\circ\text{C}$ unless otherwise specified)

Diode Forward Voltage	V_{DSF}	$I_{DR} = 6\text{A}, V_{GS} = 0\text{V}$	—	0.92	—	V
Reverse Recovery Time	t_{rr}	$I_{DR} = 6\text{A}, V_{GS} = 0\text{V}, di/dt = 50\text{A}/\mu\text{s}$	—	155	—	ns
Reverse Recovered Charge	Q_{rr}		—	930	—	nC

